

MATERIAL LITIGATION AMKOR'S COMPLAINT

MALAYSIAN PACIFIC INDUSTRIES BERHAD

Type	Announcement
Subject	MATERIAL LITIGATION
Description	AMKOR'S COMPLAINT

We refer to the update in the Malaysian Pacific Industries Berhad ("MPI")'s Quarterly Report for the 1st quarter ended 30 September 2012 in respect of the on-going patent litigation between Carsem (M) Sdn Bhd, Carsem Semiconductor Sdn Bhd (now known as Recams Sdn Bhd) and Carsem Inc. (collectively referred to as "Carsem") and Amkor Technology, Inc ("Amkor") in the International Trade Commission ("ITC") in Washington, D.C.

MPI now writes to inform that the United States ("US") Court of Appeals for the Federal Circuit ("CAFC") has denied Carsem's petition for re-hearing of the appeal. The case will be remanded to the ITC for further proceedings consistent with the CAFC's decision.

In the meantime, Carsem has submitted a request to the US Patent Office for re-examination of Amkor's relevant patent and the US Patent Office has granted Carsem's request for re-examination of all claims of the patent in question.

This announcement is dated 13 December 2012.

Announcement Info

Company Name	MALAYSIAN PACIFIC INDUSTRIES BERHAD
Stock Name	MPI
Date Announced	13 Dec 2012
Category	General Announcement
Reference No	MM-121213-35173